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February 2014

# 74VHC74 Dual D-Type Flip-Flop with Preset and Clear

### Features

- High Speed: f<sub>MAX</sub> = 170MHz (typ.) at T<sub>A</sub> = 25°C
- High noise immunity:  $V_{NIH} = V_{NIL} = 28\% V_{CC}$  (min.)
- Power down protection is provided on all inputs
- Low power dissipation: I<sub>CC</sub> = 2µA (max.) at T<sub>A</sub> = 25°C
- Pin and function compatible with 74HC74

# **General Description**

The VHC74 is an advanced high speed CMOS Dual D-Type Flip-Flop fabricated with silicon gate CMOS technology. It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation. The signal level applied to the D input is transferred to the Q output during the positive going transition of the CK pulse. CLR and PR are independent of the CK and are accomplished by setting the appropriate input LOW.

An input protection circuit ensures that 0V to 7V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5V to 3V systems and two supply systems such as battery backup. This circuit prevents device destruction due to mismatched supply and input voltages.

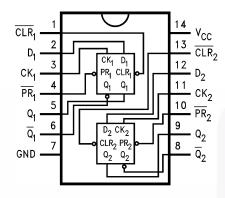
Ordering mon	nation	
Order Number	Package Number	Package Description
74VHC74M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
74VHC74SJ	M14D	14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74VHC74MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
74VHC74N	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

#### **Ordering Information**

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering number.

All packages are lead free per JEDEC: J-STD-020B standard.

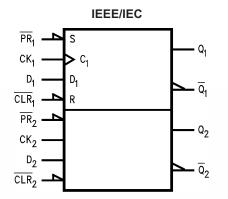
# **Connection Diagram**



# **Pin Description**

Pin Names	Description
D <sub>1</sub> , D <sub>2</sub>	Data Inputs
CK <sub>1</sub> , CK <sub>2</sub>	Clock Pulse Inputs
$\overline{\text{CLR}}_1, \overline{\text{CLR}}_2$	Direct Clear Inputs
$\overline{PR}_1, \overline{PR}_2$	Direct Preset Inputs
$Q_1, \overline{Q}_1, Q_2, \overline{Q}_2$	Output

# Logic Symbol



# Truth Table

	Inpu	ts		Out	puts	
CLR	PR	D	СК	Q	Q	Function
L	Н	Х	Х	L	Н	Clear
Н	L	Х	Х	Н	L	Preset
L	L	Х	Х	H <sup>(1)</sup>	H <sup>(1)</sup>	
Н	Н	L	~	L	Н	
Н	Н	Н	~	Н	L	
Н	Н	Х	$\sim$	Q <sub>n</sub>	$\overline{Q}_{n}$	No Change

#### Note:

1. This configuration is nonstable; that is, it will not persist when preset and clear inputs return to their inactive (HIGH) state.

# **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating
V <sub>CC</sub>	Supply Voltage	-0.5V to +7.0V
V <sub>IN</sub>	DC Input Voltage	-0.5V to +7.0V
V <sub>OUT</sub>	DC Output Voltage	-0.5V to V <sub>CC</sub> + 0.5V
I <sub>IK</sub>	Input Diode Current	–20mA
I <sub>OK</sub>	Output Diode Current	±20mA
I <sub>OUT</sub>	DC Output Current	±25mA
I <sub>CC</sub>	DC V <sub>CC</sub> /GND Current	±50mA
T <sub>STG</sub>	Storage Temperature	–65°C to +150°C
ΤL	Lead Temperature (Soldering, 10 seconds)	260°C

# Recommended Operating Conditions<sup>(2)</sup>

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Rating
V <sub>CC</sub>	Supply Voltage	2.0V to +5.5V
V <sub>IN</sub>	Input Voltage	0V to +5.5V
V <sub>OUT</sub>	Output Voltage	0V to V <sub>CC</sub>
T <sub>OPR</sub>	Operating Temperature	–40°C to +85°C
t <sub>r</sub> , t <sub>f</sub>	Input Rise and Fall Time, $V_{CC} = 3.3V \pm 0.3V$ $V_{CC} = 5.0V \pm 0.5V$	0ns/V ~ 100ns/V 0ns/V ~ 20ns/V

Note:

2. Unused inputs must be held HIGH or LOW. They may not float.

	Parameter				$T_A = 25^{\circ}C$			T <sub>A</sub> = -40°C to +85°C		
Symbol		V <sub>CC</sub> (V)	Conditions		Min.	Тур.	Max.	Min.	Max.	Units
V <sub>IH</sub>	HIGH Level Input	2.0			1.50			1.50		V
	Voltage	3.0–5.5	1		0.7 x V <sub>CC</sub>			0.7 x V <sub>CC</sub>		1
V <sub>IL</sub>	LOW Level Input	2.0		1			0.50		0.50	V
	Voltage	3.0–5.5					0.3 x V <sub>CC</sub>		0.3 x V <sub>CC</sub>	
V <sub>OH</sub>	HIGH Level Output Voltage	2.0	$V_{IN} = V_{IH}$ or $V_{IL}$	I <sub>OH</sub> = -50μA	1.9	2.0		1.9		V
		3.0			2.9	3.0		2.9		
		4.5			4.4	4.5		4.4		
		3.0		$I_{OH} = -4mA$	2.58			2.48		
		4.5	1	I <sub>OH</sub> = -8mA	3.94			3.80		1
V <sub>OL</sub>	LOW Level Output Voltage	2.0	$V_{IN} = V_{IH}$ or $V_{IL}$	I <sub>OL</sub> = 50μA		0.0	0.1		0.1	V
		3.0				0.0	0.1		0.1	
		4.5				0.0	0.1		0.1	
		3.0		$I_{OL} = 4mA$			0.36		0.44	
		4.5		I <sub>OL</sub> = 8mA			0.36		0.44	
I <sub>IN</sub>	Input Leakage Current	0–5.5	V <sub>IN</sub> = 5.5V	or GND			±0.1		±1.0	μA
I <sub>CC</sub>	Quiescent Supply Current	5.5	$V_{IN} = V_{CC}$	or GND			2.0		20.0	μA

74VHC74 — Dual D-Type Flip-Flop with Preset and Clear

## **AC Electrical Characteristics**

				т	T <sub>A</sub> = 25°C		T <sub>A</sub> = -40°C to +85°C		
Symbol	Parameter	V <sub>CC</sub> (V)	Conditions	Min.	Тур.	Max.	Min.	Max.	Units
f <sub>MAX</sub>	Maximum Clock	3.3 ± 0.3	$C_L = 15 pF$	80	125		70		MHz
	Frequency		$C_L = 50 pF$	50	75		45		
		5.0 ± 0.5	$C_L = 15 pF$	130	170		110		
			$C_L = 50 pF$	90	115		75		
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay Time (CK-Q, Q)	3.3 ± 0.3	$C_L = 15 pF$		6.7	11.9	1.0	14.0	ns
			$C_L = 50 pF$		9.2	15.4	1.0	17.5	
		5.0 ± 0.5	$C_L = 15 pF$		4.6	7.3	1.0	8.5	1
			$C_L = 50 pF$		6.1	9.3	1.0	10.5	
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay Time (CLR, PR -Q, Q)	3.3 ± 0.3	$C_L = 15 pF$		7.6	12.3	1.0	14.5	ns
			$C_L = 50 pF$		10.1	15.8	1.0	18.0	
		5.0 ± 0.5	$C_L = 15 pF$		4.8	7.7	1.0	9.0	
			$C_L = 50 pF$		6.3	9.7	1.0	11.0	
C <sub>IN</sub>	Input Capacitance		V <sub>CC</sub> = Open		4	10		10	pF
C <sub>PD</sub>	Power Dissipation Capacitance		(3)		25				pF

#### Note:

3. C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained from the equation:  $I_{CC}$  (opr.) = C<sub>PD</sub> • V<sub>CC</sub> • f<sub>IN</sub> + I<sub>CC</sub> / 2 (per F/F).

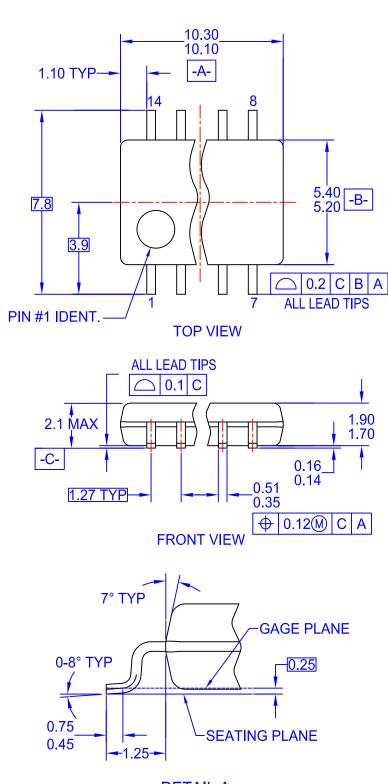
# AC Operating Requirements

			T <sub>A</sub> = 25°C		T <sub>A</sub> = -40°C to +85°C	
Symbol	Parameter	V <sub>CC</sub> (V) <sup>(4)</sup>	Тур.		aranteed inimum	Units
t <sub>W</sub> (L), t <sub>W</sub> (H)	Minimum Pulse Width (CK)	3.3		6.0	7.0	ns
		5.0		5.0	5.0	
t <sub>W</sub> (L)	Minimum Pulse Width (CLR, PR)	3.3		6.0	7.0	ns
		5.0		5.0	5.0	
t <sub>S</sub>	Minimum Setup Time	3.3		6.0	7.0	ns
		5.0		5.0	5.0	
t <sub>H</sub>	Minimum Hold Time	3.3		0.5	0.5	ns
		5.0		0.5	0.5	
t <sub>REC</sub>	Minimum Recovery Time (CLR, PR)	3.3		5.0	5.0	ns
		5.0		3.0	3.0	1

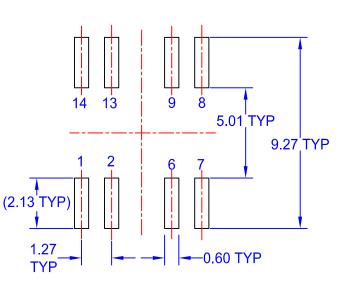
#### Note:

4.  $V_{CC}$  is 3.3  $\pm$  0.3V or 5.0  $\pm$  0.5V

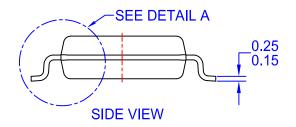








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